

TRANSMITTAL LETTER (General - Patent Pending)

Docket No. END920010115US2

Darbha et al.

Filing Date 7/29/03

Examiner

Group Art Unit

Nguyen, Dilinh P.

2814

Title: STRESS REDUCTION IN FLIP-CHIP PBGA PACKAGING BY UTILIZING SEGMENTED CHIPS AND/OR CHIP CARRIERS

TO THE COMMISSIONER FOR PATENTS:

Transmitted herewith is:

Amendment (10 pages)

Figure 7 (1 page)

in the above identified application.

- No additional fee is required.
- A check in the amount of

is attached.

The Director is hereby authorized to charge and credit Deposit Account No.

09-0457(IBM)

as described below.

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Jack P. Fredna Signature

Dated: 3/31/2004

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I certify that this document and fee is being deposited with the U.S. Postal Service as on 3/31/2004 first class mail under 37 C.F.R. 1.8 and is addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-/1450.

Signature of Person Mailing Correspondence

Kim Dwileski

Typed or Printed Name of Person Mailing Correspondence



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Darbha et al.

Art Unit: 2814

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Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action mailed February 3, 2004, please amend the aboveidentified application as follows:

In the Drawings

Please revise the drawings in accordance with the Request for Approval of Drawing Corrections attached hereto.